3.0mmx1.0mm RIGHT ANGLE SMD CHIP LED LAMP

Part Number: APBA3010SURKCGKC-GX

Hyper Red Green

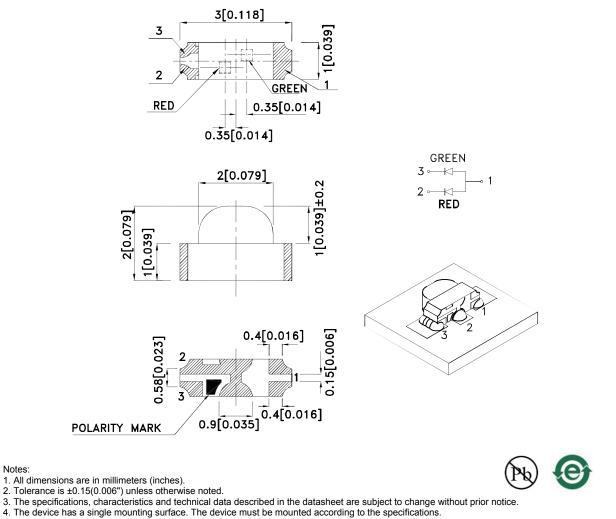
Features

- 3.0mmx1.0mm right angle SMT LED, 2.0mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package : 2000 pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Package Dimensions

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode. The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.



REV NO: V.2 CHECKED: Allen Liu DATE: DEC/28/2010 DRAWN: C.H.HAN PAGE: 1 OF 6 ERP: 1203012000

Selection Guide lv (mcd) [2] Viewing @ 20mA Angle [1] Part No. Dice Lens Type 201/2 Min. Тур. Hyper Red (AlGaInP) 120 300 APBA3010SURKCGKC-GX 140° Water Clear Green (AlGaInP) 40 70

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	650 574		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 570		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 20		nm	I⊧=20mA
С	Capacitance	Hyper Red Green	35 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green	1.95 2.1	2.5 2.5	V	I⊧=20mA
lr	Reverse Current	Hyper Red Green		10 10	uA	VR = 5V

Notes: 1.Wavelength: +/-1nm.

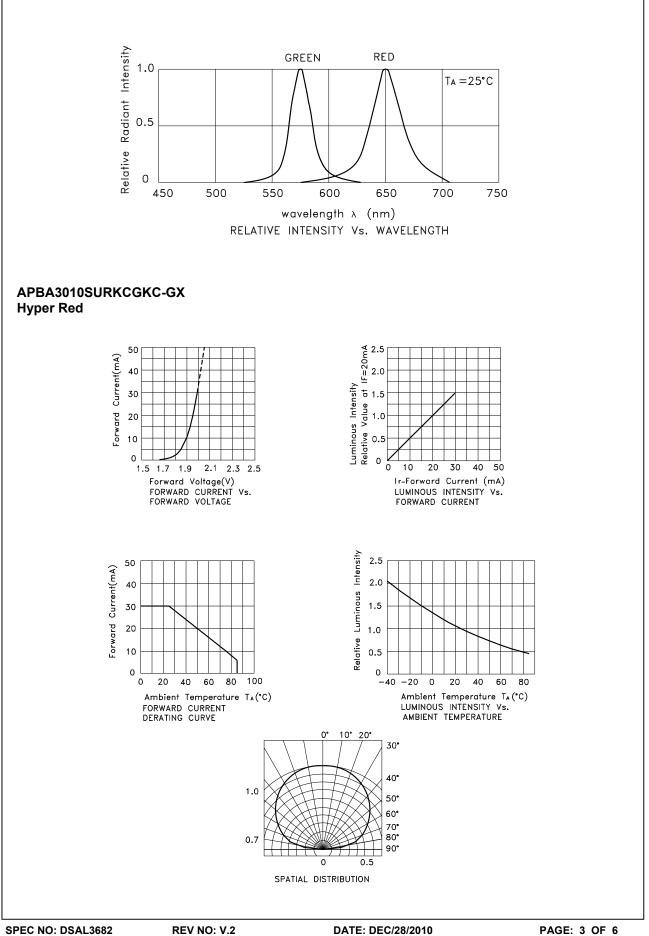
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

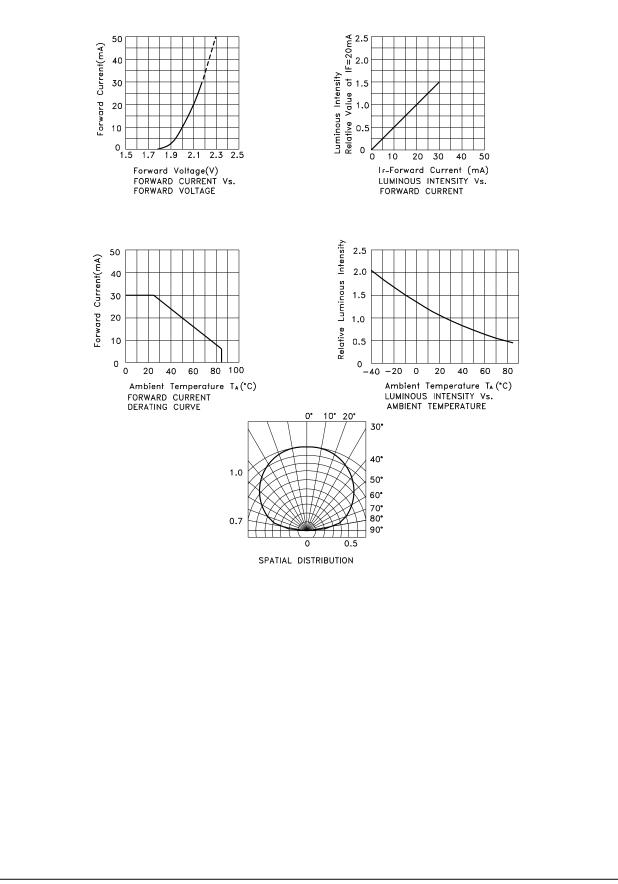
Parameter	Hyper Red	Green	Units		
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	185	150	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



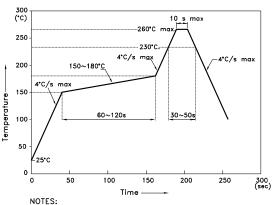
Green



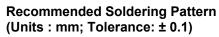
APBA3010SURKCGKC-GX

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

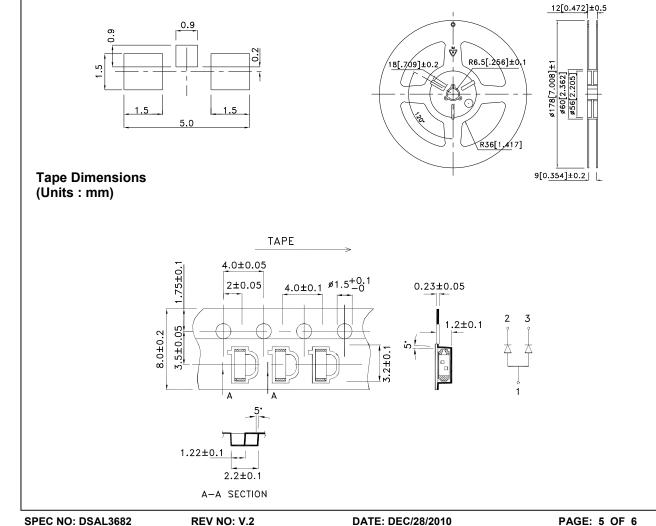
Reflow Soldering Profile For Lead-free SMT Process.



NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.



Reel Dimension



CHECKED: Allen Liu

DRAWN: C.H.HAN

